



42.P17276
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Lei, et al.

Serial No.: 10/672,033

Filed: September 25, 2003

For: GERMANIUM-ON-INSULATOR
FABRICATION UTILIZING WAFER
BONDING

Examiner: Shamim Ahmed


Group Art Unit: 1765

Attorney Docket No.: 42.P17276

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PRELIMINARY AMENDMENT

Hon. Assistant Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Prior to examination of the claims on the merits, Applicants respectfully request that the Examiner enter the following amendments and consider the following remarks:

Amendments to the Claims begin on page 2.

Remarks/Arguments begin on page 5